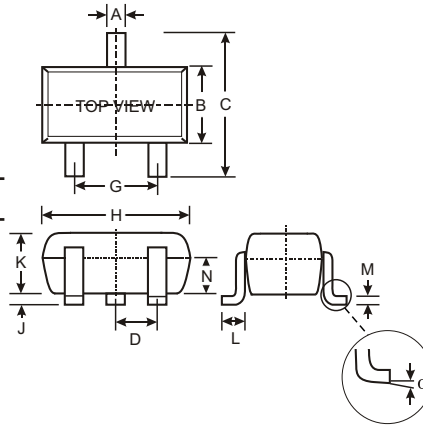


### Features

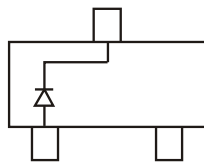
- Ultra-Small Surface Mount Package
- Low Forward Voltage Drop
- Fast Switching
- PN Junction Guard Ring for Transient and ESD Protection
- Available in Lead Free Version

### Mechanical Data

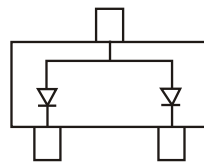
Case: SOT-523, Molded Plastic  
 Case material - UL Flammability Rating 94V-0  
 Moisture sensitivity: Level 1 per J-STD-020A  
 Terminals: Solderable per MIL-STD-202, Method 208  
 Also Available in Lead Free Plating (Matte Tin Finish). Please See Ordering Information, Note 4, on Page 2  
 Polarity: See Diagrams Below  
 Marking: See Diagrams Below & Page 2  
 Weight: 0.002 grams (approx.)  
 Ordering Information, see Page 2



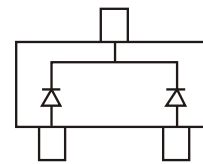
SOT-523			
Dim	Min	Max	Typ
A	0.15	0.30	0.22
B	0.75	0.85	0.80
C	1.45	1.75	1.60
D			0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
J	0.00	0.10	0.05
K	0.60	0.80	0.75
L	0.10	0.30	0.22
M	0.10	0.20	0.12
N	0.45	0.65	0.50
	0	8	
All Dimensions in mm			



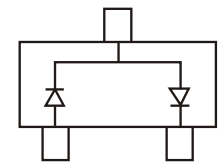
BAT54T Marking: L1



BAT54AT Marking: L2



BAT54CT Marking: L3



BAT54ST Marking: L4

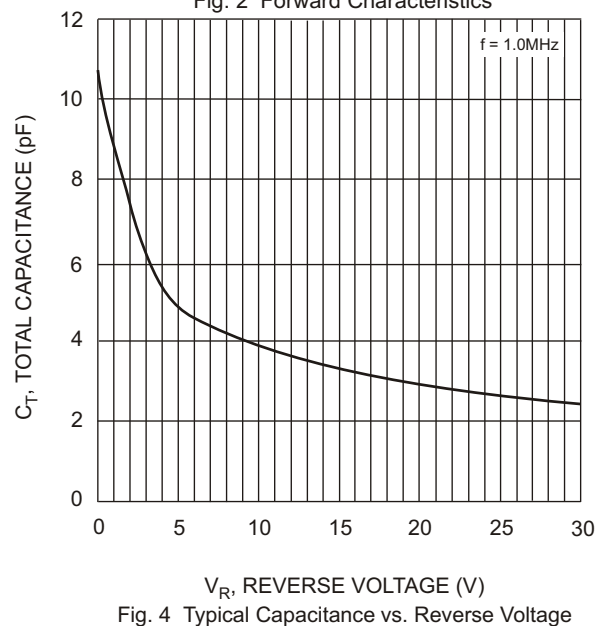
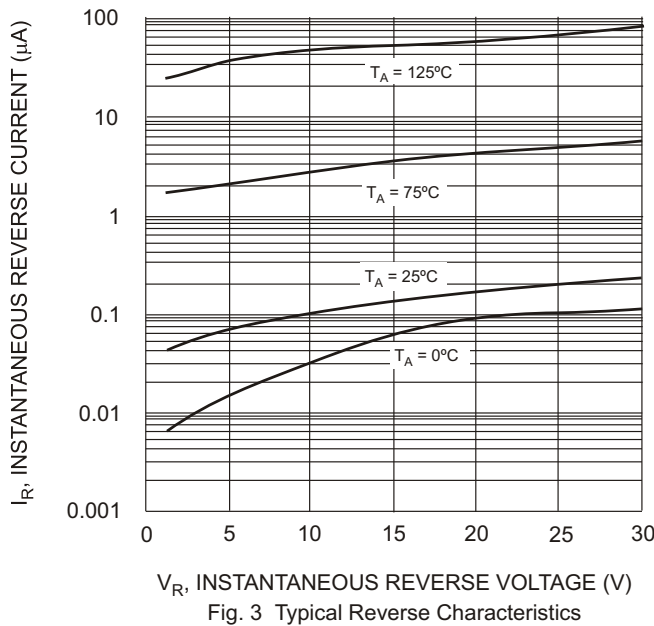
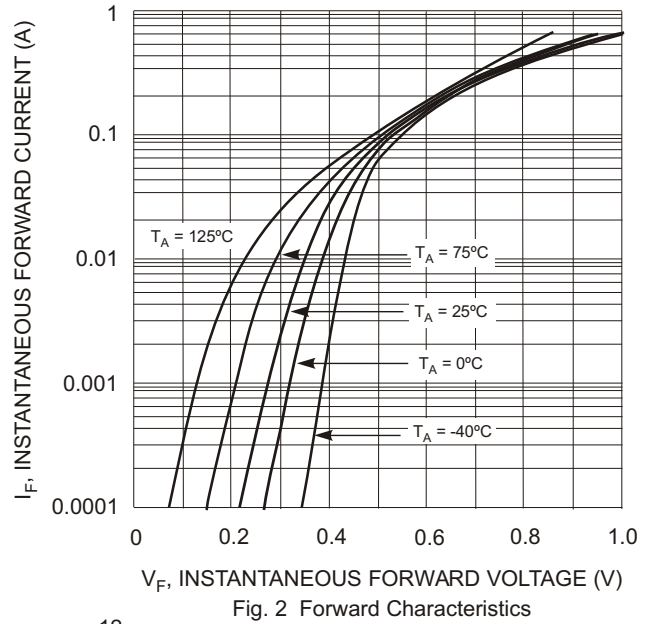
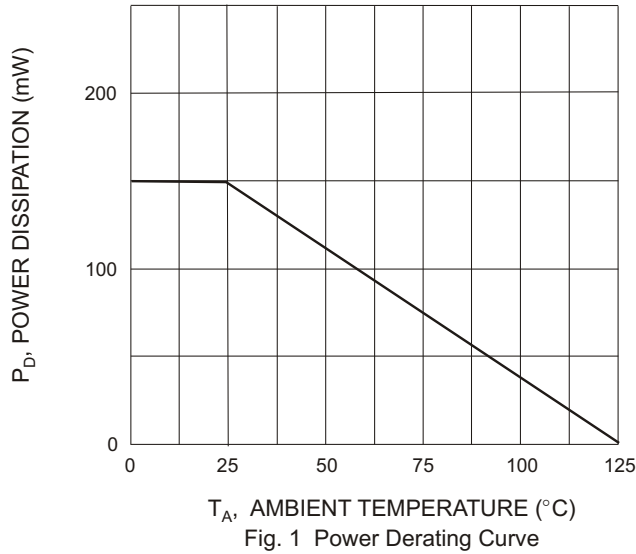
### Maximum Ratings @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Forward Continuous Current (Note 1)	I <sub>FM</sub>	200	mA
Repetitive Peak Forward Current	I <sub>FRM</sub>	300	mA
Forward Surge Current @ t < 1.0s	I <sub>FSM</sub>	600	mA
Power Dissipation (Note 1)	P <sub>d</sub>	150	mW
Thermal Resistance, Junction to Ambient (Note 1)	R <sub>JA</sub>	833	C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +125	C

### Electrical Characteristics @ T<sub>A</sub> = 25 C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	30			V	I <sub>R</sub> = 100 A
Forward Voltage (Note 2)	V <sub>F</sub>			240 320 400 500 1000	mV	I <sub>F</sub> = 0.1mA I <sub>F</sub> = 1mA I <sub>F</sub> = 10mA I <sub>F</sub> = 30mA I <sub>F</sub> = 100mA
Reverse Leakage Current (Note 2)	I <sub>R</sub>			2.0	A	V <sub>R</sub> = 25V
Total Capacitance	C <sub>T</sub>			10	pF	V <sub>R</sub> = 1.0V, f = 1.0MHz
Reverse Recovery Time	t <sub>rr</sub>			5.0	ns	I <sub>F</sub> = 10mA through I <sub>R</sub> = 10mA to I <sub>R</sub> = 1.0mA, R <sub>L</sub> = 100

- Notes: 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.  
 2. Short duration test pulse used to minimize self-heating effect.

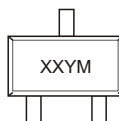


**Ordering Information** (Note 3 and 4)

Device	Packaging	Shipping
BAT54T-7	SOT-523	3000/Tape & Reel
BAT54AT-7	SOT-523	3000/Tape & Reel
BAT54CT-7	SOT-523	3000/Tape & Reel
BAT54ST-7	SOT-523	3000/Tape & Reel

- Notes: 3. For Packaging Details: go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.  
4. For lead free terminal plating part number, please add "-F" suffix to part number above. Example: BAT54T-7-F.

**Marking Information**



XX = Product Type Marking Code (See Page 1, e.g. L1 = BAT54T)  
 YM = Date Code Marking  
 Y = Year (ex: N = 2002)  
 M = Month (ex: 9 = September)

Date Code Key

Year	2002	2003	2004	2005	2006	2007	2008	2009
Code	N	P	R	S	T	U	V	W

Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D